

RJK0384DPA

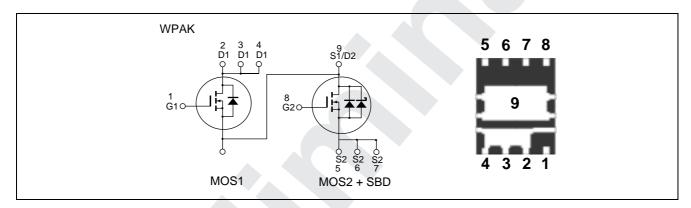
Silicon N Channel Power MOS FET with Schottky Barrier Diode High Speed Power Switching

> REJ03G1724-0101 Preliminary Rev.1.01 Jul 10, 2008

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Pb-free
- Halogen-free

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

		Ra	tings		
Item	Symbol	MOS1	MOS2	Unit	
Drain to source voltage	V _{DSS}	30	30	V	
Gate to source voltage	V _{GSS}	±20	±20	V	
Drain current	I _D	15	42	А	
Drain peak current	I _{D(pulse)} Note1	60	168	А	
Reverse drain current	I _{DR}	15	42	А	
Avalanche current	I _{AP} Note 2	11	18	А	
Avalanche energy	E _{AR} Note 2	12.1	32.4	mJ	
Channel dissipation	Pch Note3	10	25	W	
Channel temperature	Tch	150	150	°C	
Storage temperature	Tstg	−55 to +150	−55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. Tc=25°C

Electrical Characteristics

• MOS1

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	8.5	11.1	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	12	16.8	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	_	TBD	_	S	$I_D = 7.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	1010	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	190	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	75	_	pF	f = 1MHz
Gate Resistance	Rg	_	1.2	_	Ω	
Total gate charge	Qg	_	6.8	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	2.5	_	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Qgd	_	1.5	_	nC	I _D = 15 A
Turn-on delay time	t _{d(on)}	_	TBD	_	ns	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$
Rise time	t _r	_	TBD		ns	V _{DD} ≅ 10 V
Turn-off delay time	t _{d(off)}	_	TBD		ns	$R_L = 1.33 \Omega$
Fall time	t _f		TBD	_	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	V_{DF}	_	0.84	1.10	V	$I_F = 15 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-drain diode reverse	t _{rr}		20		ns	$I_F = 15 \text{ A}, V_{GS} = 0$
recovery time						di _F / dt = 100 A/μs

Notes: 4. Pulse test



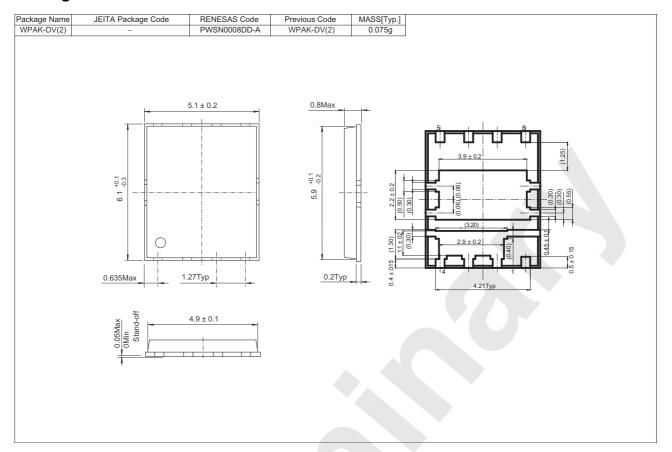
• MOS2

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I_{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	_	_	1	mA	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	2.9	3.8	mΩ	$I_D = 21 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	4.3	6.0	mΩ	$I_D = 21 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	_	TBD	_	S	$I_D = 21 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	2400	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	500	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	230	_	pF	f = 1MHz
Gate Resistance	Rg	_	2.0	_	Ω	
Total gate charge	Qg	_	17	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	6.5	_	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Qgd	_	5.2	_	nC	$I_D = 42 \text{ A}$
Turn-on delay time	t _{d(on)}	_	TBD	_	ns	V _{GS} = 10 V, I _D = 21 A
Rise time	t _r	_	TBD		ns	V _{DD} ≅ 10 V
Turn-off delay time	t _{d(off)}	_	TBD	/ -	ns	$R_L = 0.47 \Omega$
Fall time	t _f	_	TBD	V —	ns	$R_g = 4.7 \Omega$
Schottky Barrier diode forward voltage	V _F		0.39		V	$I_F = 2 A$, $V_{GS} = 0$ Note4
Body-drain diode reverse	t _{rr}	_	23	-	ns	$I_F = 42 \text{ A}, V_{GS} = 0$
recovery time						$di_F/dt = 100 A/\mu s$

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK0384DPA-00-J0	2500 pcs	Taping

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